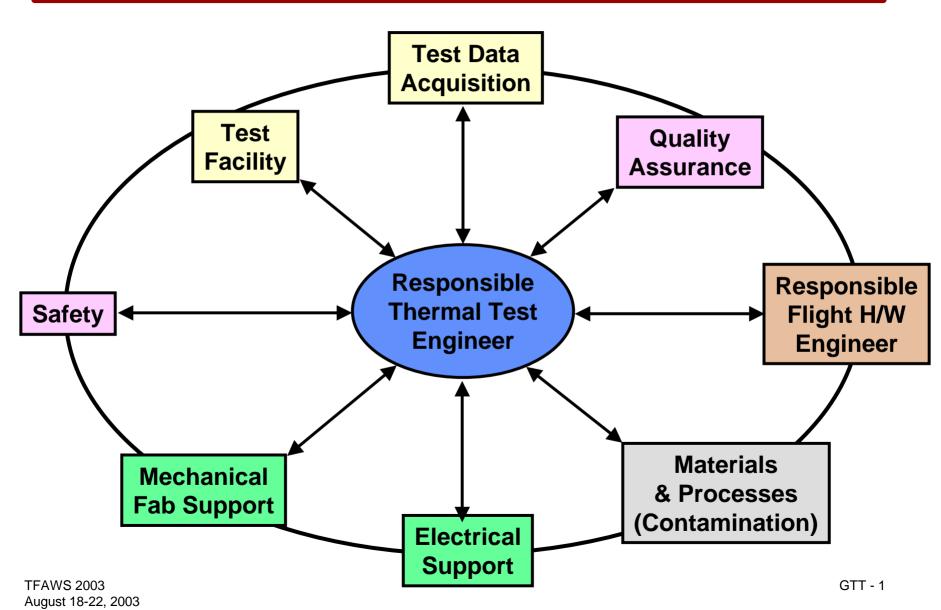




The World According to the Thermal Test Engineer







Your Role as Thermal Test Engineer

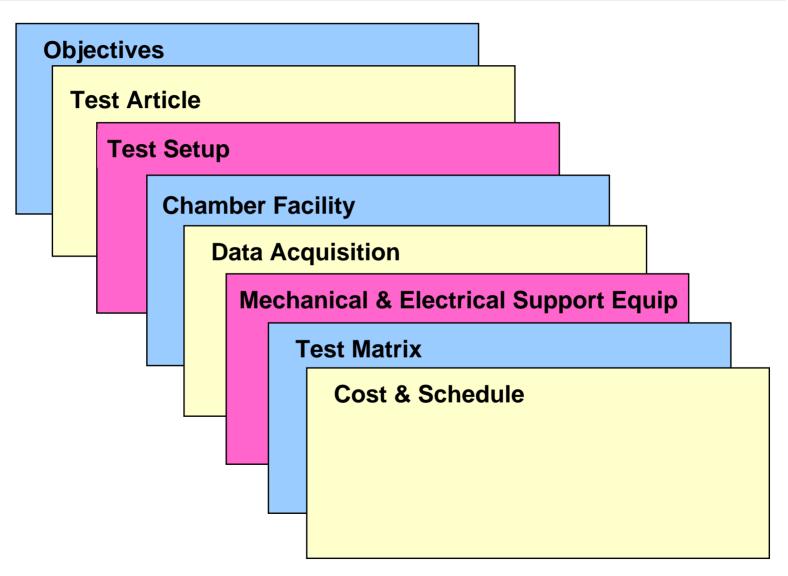


- Understanding your role as responsible thermal test engineer
 - Clear and decisive communication with your interfaces is critical
 - Be proactive; attend to issues quickly & prevent new ones from arising
 - Develop well-defined and verifiable test objectives
 - · This will define how the test will be simulated and instrumented
 - Identify special tests
 - Know your responsibilities for ensuring hardware & personnel safety
- Planning becomes more intertwined with other parties as you move from a thermal development test to an assembly-level qualification/acceptance test to a system-level thermal test
- Test planning involves a significant amount of your time & effort so allocate ample time in your schedule



Elements of the Test Plan







Planning: "Rome Wasn't Built in a Day" (1/3)



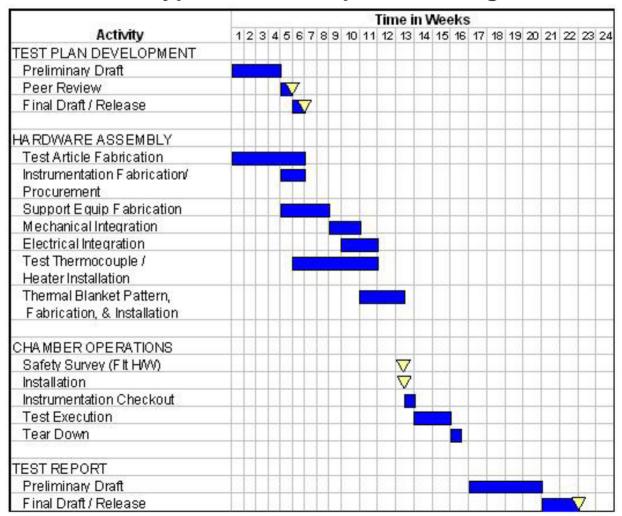
- Why is a plan needed?
 - Tool that initiates & guides the test planning & preparation process
 - Acts as the driver to totally engage the responsible thermal test engineer
 - · Allows you to stay on top of all test aspects, even as the test evolves
 - Stimulates feedback from the key interfaces
 - Leads to a more efficient use of resources



Planning: "Rome Wasn't Built in a Day" (2/3)



- How long does the planning & preparation process take?
 - Schedule shown is typical of development testing





Planning: "Rome Wasn't Built in a Day" (3/3)



Thermal Test Short Course

High-level schedule for system thermal testing (STT)

Event	Timing					
Preliminary STT Concept	Thermal PDR					
STT Preliminary Plan Peer Review	4 Weeks Prior to Thermal CDR					
Preliminary STT Plans	Thermal CDR					
Preliminary STT Plan Release	2 Weeks Prior to ETRR					
Preliminary STT Plan Summary	ETRR					
STT Final Plan Peer Review	6 Weeks Prior to STT Start					
STT Final Plan Project Review	4 Weeks Prior to STT Start					
STT Final Plan Sign-off	2 Weeks Prior to STT Start					
STT Preliminary Results Presentation	1 Week After STT End					
STT Final Test Report Peer Review	10 Weeks after STT End					
STT Final Test Report Release	3 Months After STT End					



Objectives: "The Chicken is Involved for Eggs; The Pig is Committed for Pork"



- Test objectives are the very core of the test
 - Specific
 - Verifiable from the test results
- Objectives fall into two categories
 - Primary
 - Secondary or Special
- Primary objectives
 - Very often, linked to Project Level 3 & 4 requirements
 - "To determine the survival heater power for the worst-case cold Martian surface thermal environment"
 - "To demonstrate in-specification telescope optical performance at the hot and cold flight acceptance temperature levels"
 - "To verify that the temperature control design will maintain the spacecraft and all its elements within allowable flight temperature ranges while operating over the environmental extremes expected for the mission"



Objectives: "The Chicken is Involved for Eggs; The Pig is Committed for Pork"



- Secondary or special objectives
 - Tests present unique opportunities to obtain additional empirical information to more fully understand the thermal design
 - If properly planned, the gathering of this information will be of minimal impact to the primary test flow
 - Examples
 - Sensitivity of temperature to power
 - Optimize size of flight heaters
 - Assess effect of poorly-known or degraded thermal properties
 - Assess heater element failure
 - Sensitivity of temperature to boundary conditions
 - Determine temperature changes after switching from primary to redundant equipment
 - Obtain information for mission operations
 - How long can heaters (or equipment) be turned off?
 - > How long does it take a heater to do its warm-up job?



Objectives: "The Chicken is Involved for Eggs; The Pig is Committed for Pork"



- "Permissible" temperature limits when using flight hardware
 - Although there are established Level 3 allowable flight temperature limits, there is no universally accepted interpretation of permissible limits during test
 - Permissible test limits are the criteria for the generation of problem/failure documentation
 - A balance between hardware safety & test flexibility must be struck
 - Flight hardware should be only exposed to temperature levels within previous environmental test experience
 - At JPL, flight acceptable (FA) test limits have constituted permissible test limits
 - Enabled testing to continue when marginal allowable flight temperature violations occurred
 - You must unambiguously define these limits & reach agreement with the appropriate parties <u>before the test begins</u>



Test Article: What Is It That We're Testing?



- Developmental testing usually uses non-flight hardware
 - You must define the key thermal requirements for the fabrication of the test article
 - How important is fit & form?
 - How important is the article mass?
 - How will internal power be simulated?
 - Replication of heat transfer paths including radiation (i.e., surface finish)
 - Egress of test heater & temperature sensor cabling
 - Avoid cadmium-plated fasteners (not vacuum qualified)
 - Use of flight hardware will complicate the test planning
- Protoflight/Qualification & Flight Acceptance testing involves flight hardware
- System-level testing involves primarily flight hardware
 - However, EM or QUAL units may be used as substitutes when flight hardware is late
 - You will need to assess the impact to your objectives if such substitutions occur



Test Set-up Considerations



- How will the test article be installed?
 - Hanging
 - Need for proof-loading support hardware
 - Securing hardware in the event of an emergency
 - Floor Fixture
 - Need for blanketing & return-to-ambient heater
 - · Availability of facility crane to assist chamber installation
- What other mechanical and/or electrical support equipment is required?
 - Plumbing for active coldplates and/or other fluid systems
 - Support structure for coldplates, lamps, calibration targets, etc.
 - In-situ test camera provisions



Test Facilities Considerations



- Ensure that the facility has been certified for the environmental testing that you will conduct
 - Facility safety survey
 - Cleanliness
- Select minimally-sized chamber subject to:
 - Test objectives
 - Critical mechanical clearances to chamber wall
 - Accommodation of other support hardware
- Most thermal tests require a cold shroud
 - Understand temperature ranges & stability
 - Understand impact of close proximity of the test article to shroud
 - Do you also require a door shroud?
- Optical test articles may require a chamber window
 - Special thermal considerations to reduce impact of window
 - · Reduce aperture area with thermal blanketing or highly reflective shield
 - Use a long-length chamber & place test article as far from the window as possible
- Ensure that the surrounding external chamber area is sufficient for staging and accommodation any GSE



Test Data Acquisition Planning (1/2)



- How do you determine where the thermocouples & test heaters are located?
 - Temperature data that will directly lead to verifying your objectives
 - Temperature data that will provide a better understanding of your design
 - Temperature data that will not be measured in-flight
 - What hardware requires safeguarding in event of a facility failure or test problem?
 - Consider supplementing flight heaters where practical
 - Accelerate achievement of steady-state
 - · Accelerate transition to return-to-ambient
 - Consider in-situ massive support equipment which need warm-up acceleration upon return-to-ambient
- Defining computed data from raw test data
 - Maximum, minimum, & average temperatures
 - Spatial temperature difference
 - Temperature rate of change
 - Internal power dissipation



Test Data Acquisition Planning (2/2)



- Defining how you want the data sampled and displayed
 - What data should be grouped together for display?
 - Define display lists & plots for implementation
 - Formulate yellow & red alarm temperature limits
- Power supply capabilities
 - Define quantity & capability
 - Voltage or current range
 - Define maximum voltage and/or current limits
 - Availability of proportional heater controllers
 - Replication of thermostatic heater control



Mechanical & Electrical Support Equipment



- Development testing will require a significant amount of mechanical fabrication support
 - Get them involved with the planning process as early as possible
 - Seek feedback about feasibility of thermal mock-up design & fabrication
 - Includes support hardware & thermal blanketing
- PF/QUAL/FA & system-level testing will require flight technicians to assemble and integrate flight hardware for the test
 - Get involved to understand the mechanical & electrical integration flow
 - Identify the need for the fabrication of support hardware
 - Develop a mutually acceptable schedule
 - Identify key times where test instrumentation & blanketing can be installed



Test Matrix Development Process (1/2)



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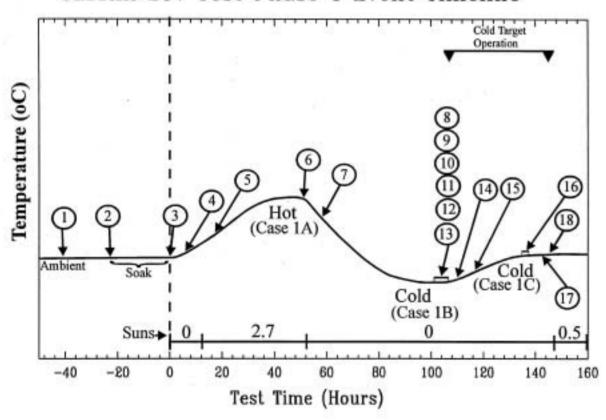


Test Matrix Development Process (2/2)



Thermal Test Short Course

Cassini STV Test Phase 1 Event Timeline



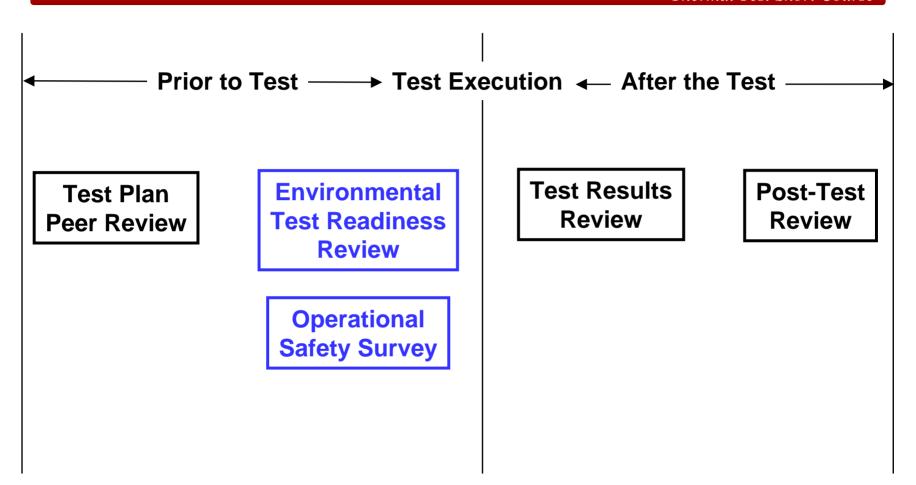
Event No.	Description						
1	S/C Baseline Test						
2	Close Chamber						
3	Nitrogen Flush						
93.	Start Cooling Shrouds						
4	Turn OFF Purge						
5	Configure Power for Case 1A						
6	Turn off Heaters TBD for Cooldown						
201	Acceleration						
7	Configure Power for Case 1B						
8	CIRS Interference Test						
9	CAPS HV Test						
10	CDA Interference Test						
11	ISS Interference Test						
12	Radar 30 minute Turn-ON						
13	RWA 30 minute Turn-ON						
14	Turn on Heaters for warm-up						
	acceleration						
15	Configure Power for Case 1C						
16	CIRS, VIMS & ISS Functional Tests						
	and CIRS Microphonics Test						
17	Configure Power for Backfill						
18	turn ON Purge						



Reviewing Your Test Plan



Thermal Test Short Course



Blue font indicates required when flight hardware present



Test Execution Considerations



- Effective use of available workforce
 - Use your discretion to determine if a test must be run around-the-clock
 - Identify primary & relief monitoring workforce
 - Identify test shift lead & communicate this information to the Facility & Integration/Test personnel
 - Ideally, limit each engineer to 1 shift for no longer than 5 consecutive days, followed by 2 non-working days
 - Critical events may warrant increased staffing
- Criteria for attainment of steady-state
 - Criteria should be used only as a guide
 - JPL has considered <0.3°C per hour for 3 consecutive hours
 - The responsible thermal test engineer shall use his/her discretion to determine when thermal equilibrium has been sufficiently approached
- Develop a prioritized emergency contact list & post at monitoring workstation



Communication Ensures Good Test Coordination



- As the responsible thermal test engineer, you must ensure that the test is performed within budget & schedule
 - Confirm that test stakeholders are aware of & buy-in to your approaches & methods
 - When multiple interfaces are involved, you should initiate regular meetings to stay on top of & help resolve any issues
- Communicate regularly with mechanical and/or electrical fabrication personnel, especially during the fabrication process
- Maintain a presence in the Integration & Test arena since this activity is "fast & furious"
 - Decisions are sometimes made informally & quickly
 - "Out of sight; out of mind"
 - A dedicated thermal engineer for this purpose is ideal



Be Proactive: Contingency Planning



- Consider design weaknesses that may be uncovered as deficient
 - With & without breaking chamber, what additional testing could be performed?
 - · Provide schedule margin to recover from a design deficiency
 - Could some design feature be included in the test setup to provide flexibility?
 - · Provide more required radiator area or heater power
 - Identify "gotta have" test cases versus "wanna have" test cases
 - Recovery from a deficiency may result in deletion of test cases to meet Project schedule
- Consider the opposite where the test goes faster than expected
 - What additional testing would provide high value?



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